

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1121cn8-5#pbf

(Engineering Calculation)

PDIP

(printed on: 2020-07-11 20:02:40)

**TOTAL MASS (g) : 0.498333**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001703	1000000	3417.3918457		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.149760	975000	300521.75		
		Iron (Fe)	7439-89-6	0.003686	24000	7396.65625		
		Phosphorus (P)	7723-14-0	0.000046	300	92.3077011108		
		Zinc (Zn)	7440-66-6	0.000108	700	216.722427368		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.153600</b>	<b>1000000</b>	<b>308227.46875</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.012410	1000000	24903.5957031		
		<b>External Plating Total:</b>				<b>0.012410</b>	<b>1000000</b>	<b>24903.5957031</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001228	1000000	2464.21435547		
<b>Internal Plating Total:</b>				<b>0.001228</b>	<b>1000000</b>	<b>2464.21435547</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000617	750000	1238.12719727		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000206	250000	413.377960205		
<b>Die Attach Total:</b>				<b>0.000823</b>	<b>1000000</b>	<b>1651.50512695</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.044334	135000	88964.5625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.282424	860000	566737.1875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.001642	5000	3294.98364258		
		<b>Encapsulation Total:</b>				<b>0.328400</b>	<b>1000000</b>	<b>658996.6875</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000169	1000000	339.130493164		
					<b>TOTAL MASS (g) :</b>	<b>0.498333</b>		